

IFW

Docket No.: SUP-005

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Kuang-Yu Wang, et al.

Application No.: 10/825,713

Group No.: 2841

Filing Date: 4/14/2004

Examiner: Hung S. Bui


For: "Card-Type Electronic Apparatus Assembly Using Ultrasonic Joining"

Date: June 23, 2005

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

STATUS INQUIRY

1. More than twelve months have passed since the filing of this application on April 14, 2004. No communication has been received from the Patent and Trademark Office indicating action on this application.
2. Kindly advise the undersigned of the present status of this application.



SIGNATURE OF PRACTITIONER

Patrick T. Bever
Reg. No. 33,834
BEVER, HOFFMAN & HARMS, LLP

Tel. No.: (408) 451-5902
Fax No.: (408) 451-5908
Customer No.: 22888